

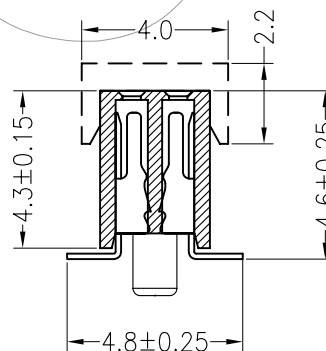
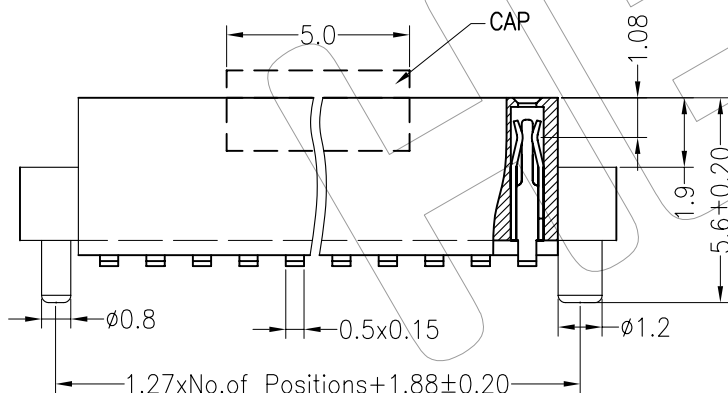
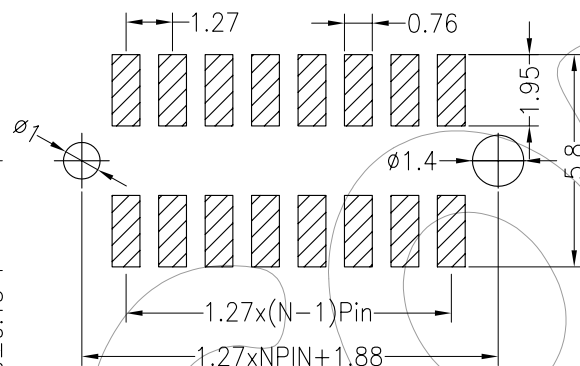
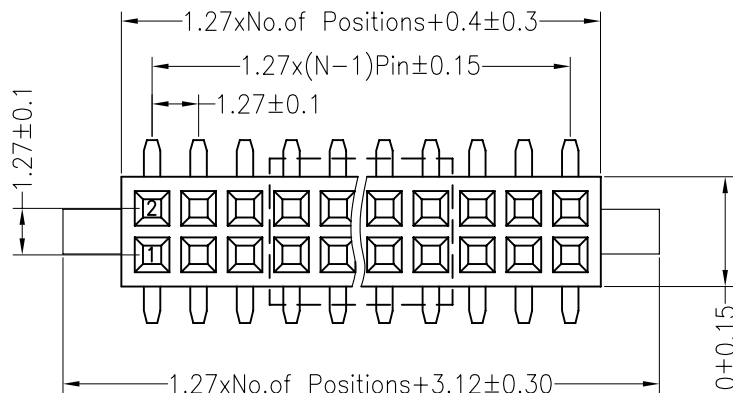
RoHS

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)

SPECIFICATIONS

Rated Current:1.0AMP
Contact Resistance:20m Ω Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000M Ω Min
Operation Temperature:-40°C to +105°C

Contact Material:Phosphor Bronze
Contact Plating:Au Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)



Ordering Information

HC-FH743 02 XX X S XX MUX 01

No.of
Pins
Per Row
2*50

Insulator Material
Option
A=BK-PBT
B=BK-PA66
C=BK-PA6T
D=BK-PA46
E=BK-PA9T
F=BK-LCP

Contact Plating
G0:Gold Flash
G2:5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
S0:Gold Flash/Tin
SN:Tin

Packing
T=Tube
P=Tube+Cap
R=Reel+Cap
M=Reel+Mylar

OPERATION

X.X ± 0.30
X.XX ± 0.20
X.XXX ± 0.10
Angle $\pm 3^\circ$
DIM TOL

DRAW

CHECK
APPROVE

Ayang

SCALE

UNIT mm
SIZE A4
SHEET 1/1
PROJ.

FIT

mm
A4
1/1

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-FH74302XXXSXXMUX01

TITLE:

1.27mm H4.3 Dual Row SMT W3.0
Female Header